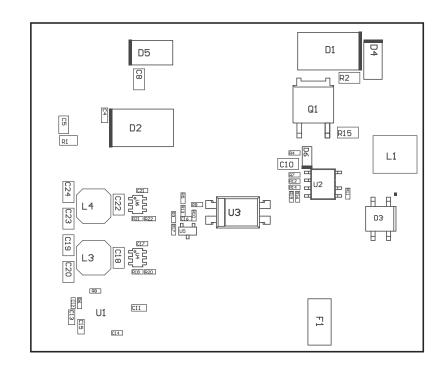


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9661	REV: A	SUN REU	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 4/3/20	014 2: 27: 53	PM	TEXAS INSTRUMENTS



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9661	REV: A	SUN REV: Not In VersionControl	
	Bottom Overlay <- 390001			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 4/3/20	014 2:27:54	PM	TEXAS INSTRUMENTS

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